EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	12	"5660642".pn. or "5601655".pn. or "4004045".pn. or "6412500".pn. or "5270079".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/24 10:47
L3	6	"5660642".pn. or "5601655".pn. or "4004045".pn. or "6412500".pn. or "5270079".pn. or "20010029978"	US-PGPUB; USPAT; USOCR	OR	ON	2009/02/24 10:48
L5	7	"6090711".pn. or "6015462".pn. or "2002023671"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/24 11:02
L6	228387	(treat$4 or etch$3 or coat$3) with (one adj5 (side$1 or surface$1))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/24 11:24
L7	484	L6 and (silicon adj wafer$1) and solar	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/24 11:27
L8	14	L7 and ((mov$3 or convey$3) with horizontal$2)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/24 11:31
L9	68080	L6 and ((treat$4 or etch$3 or coat$3) with ((silicon adj wafer$1) or substrate$1))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/24 11:33
L10	14	L8 and ((mov$3 or convey$3) with horizontal$2)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/24 11:34
L11	1794	L9 and ((mov$3 or convey$3) with horizontal$2)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/24 11:36

L12	255735	(treat$4 or etch$3 or coat$3 or clean$3) with (one adj5 (side$1 or surface$1))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/24 11:48
L13	9475	L12 and ((mov$3 or convey$3) with horizontal$2)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/24 11:49
L15	201	L13 and (treat$4 or etch$3 or coat$3 or clean$3) with (liquid adj (bath or tank or container))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/24 12:05
L16	33050	L12 and ((mov$3 with horizontal$2) or convey$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/24 12:06
L17	485	L16 and (treat$4 or etch$3 or coat$3 or clean$3) with (liquid adj (bath or tank or container))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/24 12:06
L18	281	L17 and roller$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/24 12:07
L21	195273	(treat$4 or etch$3 or coat$3 or clean$3) with ((semiconductor or silicon) adj2 (substrate$1 or wafer $1 or workpiece$1))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/24 14:10
L22	13579	L21 and ((mov$3 with horizontal$2) or convey $3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/24 14:11
L23	150	L22 and (treat$4 or etch$3 or coat$3 or clean$3) with (liquid adj (bath or tank or container))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/24 14:12
L27	197	L22 and ((treat$4 or etch$3 or coat$3 or clean$3) same (liquid adj (bath or tank or container)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/24 14:57

L28	47	L27 not L23	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/24 14:58
L29	15	(US-20030194497-$ or US-20040020905-$).did. or (US-6412500-$ or US-5601655-$ or US-6090711-$ or US-6015462-$ or US-RE37973-$ or US-5853495-$ or US-3898145-$ or US-6306224-$ or US-5839460-$ or US-5820688-$ or US-5690750-$ or US-6391145-$).did. or (WO-9917344-$).did.	US-PGPUB; USPAT; DERWENT	OR	ON	2009/02/24 15:16

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